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In re the Application

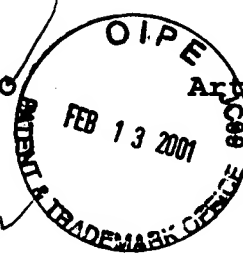
Inventors: Masanori MINAMIO

Art Unit: 2811

Application No.: 09/380,312 ✓

Filed: August 31, 1999 ✓

For: RESIN MOLDED TYPE SEMICONDUCTOR DEVICE AND A  
METHOD OF MANUFACTURING THE SAME ✓



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H. Coe  
CFR

REQUEST FOR CORRECTED FILING RECEIPT

Assistant Commissioner of Patents  
Washington, D.C. 20231

Sir:

Please issue a Corrected Filing Receipt reflecting corrected  
continuing filing data as follows:

Filing Date: August 31, 1999

A copy of the Filing Receipt with changes marked in red ink  
is attached.

Respectfully submitted,

A handwritten signature in dark ink, appearing to read "James E. Ledbetter".

Date: February 13, 2001

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JEL/clw

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO.	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/380,312	09/24/2000 08/31/1999	2811	1438	JEL-30763- PC	6	15	9

Stevens Davis Miller & Mosher  
Suite 850  
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## FILING RECEIPT



\*OC000000005710278\*

Date Mailed: 01/26/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

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## Continuing Data as Claimed by Applicant

THIS APPLICATION IS A 371 OF PCT/JP98/02544 06/08/1998

## Foreign Applications

JAPAN 9-171395 06/27/1997  
JAPAN 10-73711 03/23/1998

## Title

Resin molded type semiconductor device and a method of manufacturing the same

## Preliminary Class

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